EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

High Performance SMD LED with Reflector

Features

- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow
- solder process.EIA std. package.
- IC compatible.
- Pb- free.
- The product itself will remain within RoHS compliant version.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Indicator and backlight for audio and video equipment
- Indicator and backlight for battery driven equipment.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- General use.

Device Selection Guide

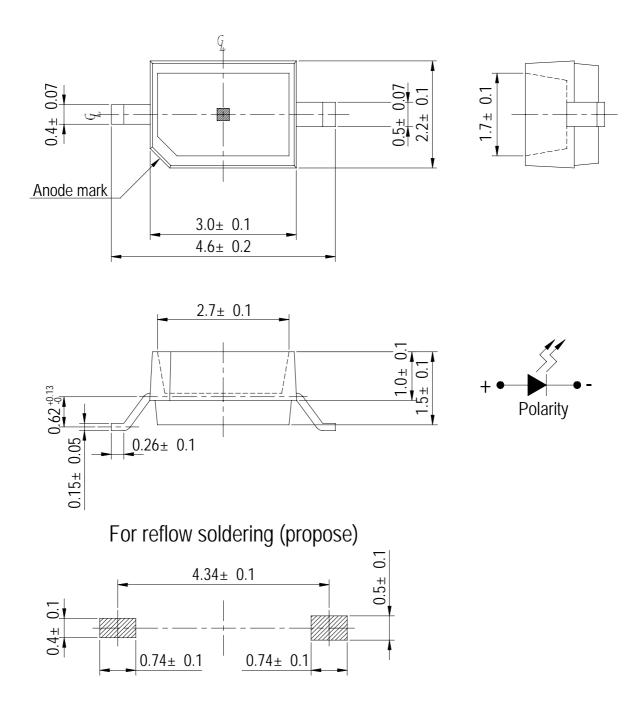
	Lens Color			
Material	Material Emitted Color			
AlGaInP	Brilliant Red	Water Clear		



93-21SURC/S530-XX/TR8



Package Dimensions



Notes: All dimensions are in millimeters. Tolerances unspecified are±0.1mm

<u>93-21SURC/S530-XX/TR8</u>

Absolute Maximum Ratings (Ta=25°C)

	U		- /							
Parameter			Symbol		Rating				Unit	
Reverse Voltage			VR	V _R 5			V			
Forward Current			IF		25				mA	
Operating Temperature			Topr		-40 ~ +85				°C	
Storage Temperature			Tstg	Tstg -40 ~ +100			°C			
Electrostatic Discharge(HBM)			ESD		2000				V	
Power Dissipation			Pd		60			mW		
Peak Forward Current (Duty 1/10 @1KHz)			Ifp		60			mA		
Soldering Temperature			Tsol	-	Reflow Soldering : 260 °C for 10 se Hand Soldering : 350 °C for 3 sec					
Electro-Optical Ch	aracteri	stics (Ta	=25°C))						
Parameter	Symbol	*Chip Rank	Min.	Т	yp.	Max.	Unit	Condition		
Luminous intensity	Iv	A2	23	4	55					
		A3	40	(68		mcd IF=		IF=20mA	
		A4	50	8	82					
		A5	63	ļ	99					
		A6	80	1	35					
			125	2	215					
		A8	140	2	251					
Viewing Angle	2 0 1/2			1	30		deg	IF=20mA		
Peak Wavelength	λp			6	532		nm	IF=20mA		
Dominant Wavelength	λd			6	524		nm	IF=	20mA	
Spectrum Radiation Bandwidth	$ riangle \lambda$			4	20		nm	IF=	IF=20mA	
Forward Voltage	VF			2	2.0	2.4	V	I _F =	IF=20mA	

*67-21SURC/S530-<u>XX</u>/TR8

 \Rightarrow Chip Rank

Ir

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Reverse Current

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http://www.everlight.com

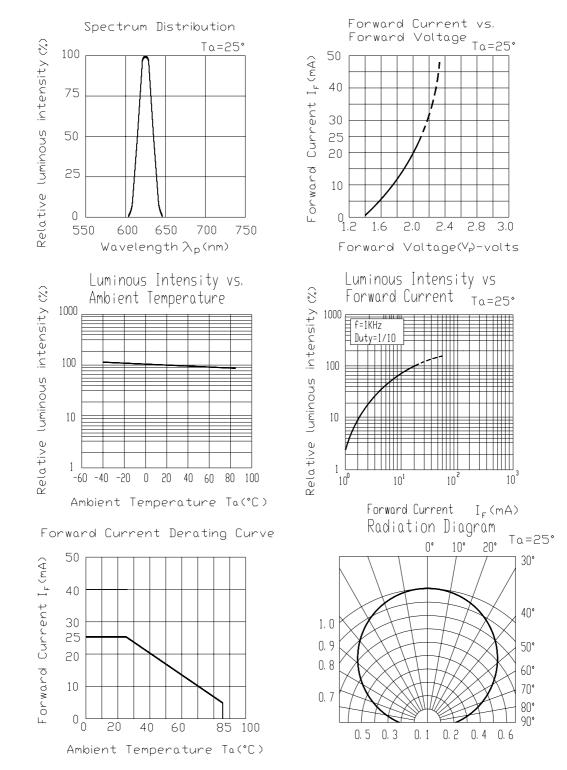
 μA

10

VR=5V

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93-21SURC/S530- XX/TR8



Typical Electro-Optical Characteristics Curves

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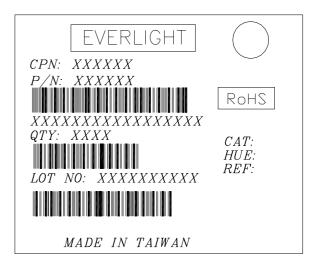
Everlight Electronics Co., Ltd. Device No. : DSE-931-089



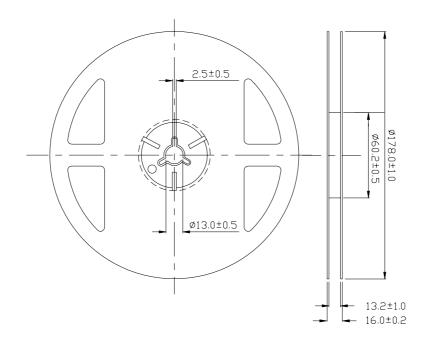
Label explanation

- **CAT: Luminous Intensity Rank**
- HUE: Dom. Wavelength Rank
- **REF: Forward Voltage Rank**

93-21SURC/S530-XX/TR8



Reel Dimensions



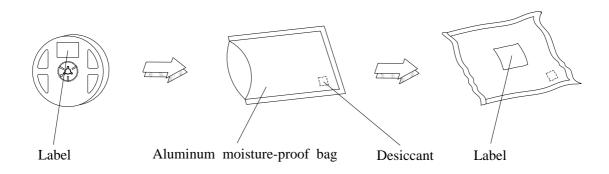
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm



Carrier Tape Dimensions: Loaded quantity 1000 PCS per reel.

Note: The tolerances unless mentioned is ± 0.1 mm Unit = mm

Moisture Resistant Packaging





Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below. Confidence level : 90%

LTPD: 10%

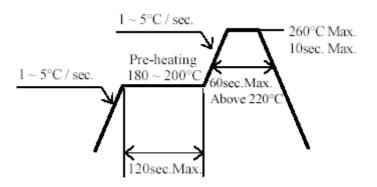
No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Solder Heat	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22PCS.	0/1
7	High Temperature / High Humidity	85℃/ 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5℃ for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

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Everlight Electronics Co., Ltd. Device No. : DSE-931-089 http://www.everlight.com Date:19-Aug-2005 Rev. 2Page: 9 of 9Prepared by: Ray Yuan